

12/98/99

PATENT NUMBER

AK Q.I.P.E. SCANNED Q.A. 18	PATENT DATE
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APPLICATION NO. 09/733289	CONT/PRIOR	CLASS 257	SUBCLASS 7	ART UNIT 2844	EXAMINER D NGUYEN G CHAILOEY
<p>APPLICANTS</p> <p>Xiao-Guang Qing Ma Marie Steven Towle</p>					
<p>TITLE</p> <p>Microplasma etching process for dual and build-up layers</p>					

[illegible]

<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>	<b>DRAWINGS</b>		<b>CLAIMS ALLOWED</b>	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.  <input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____	_____ (Assistant Examiner)		<b>NOTICE OF ALLOWANCE MAILED</b>	
	_____ (Primary Examiner)		<b>ISSUE FEE</b>	
			Amount Due	Date Paid
<input type="checkbox"/> The terminal ____ months of this patent have been disclaimed.	_____ (Legal Instruments Examiner)		<b>ISSUE BATCH NUMBER</b>	

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